# Low Resistance Metal Alloy Power Resistors

# LRMAP5930



#### Features:

- Resistance range 0.1mΩ to 3mΩ
- Excellent long-term stability
- High power rating up to 15W
- Current sensing for power electronics
- AEC-Q200 qualified



All parts are Pb-free and comply with EU Directive 2011/65/EU amended by (EU) 2015/863 (RoHS3)

### **Electrical Data**

|   |        | LRMAP5930   |     |     |     |     |     |    |     |     |
|---|--------|-------------|-----|-----|-----|-----|-----|----|-----|-----|
| Alloy type                                    | А      | A B         |     |     |     | D   | С   |    |     |     |
| Resistance value                              | mΩ     | 0.1         | 0.2 | 0.3 | 0.5 | 0.6 | 0.5 | 1  | 2   | 3   |
| Power rating, P <sub>r140</sub> <sup>1</sup>  | W      | 10          | 10  | 7   | 6   | 5   | 7   | 6  | 4   | 3   |
| Power rating, P <sub>rts70</sub> <sup>2</sup> | W      | 15          | 15  | 10  | 8   | 8   | 10  | 9  | 7   | 5   |
| Overload rating (5s) $^1$                     | W      | 50          | 50  | 35  | 30  | 25  | 35  | 30 | 20  | 15  |
| Continuous pulse energy                       | J      | 15          | 19  | 13  | 7.5 | 6   | 19  | 13 | 6.5 | 4.6 |
| Internal thermal impedance, R <sub>thi</sub>  | °C/W   | 3           | 3   | 4   | 6   | 6   | 4   | 7  | 13  | 20  |
| Resistance tolerance                          | %      |             |     |     |     | 1   |     |    |     |     |
| TCR (20 to 60°C)                              | ppm/°C | ±350 ±100   |     | ±75 |     |     | ±50 |    |     |     |
| Thermal EMF                                   | μV/°C  | <2          |     |     |     |     |     |    |     |     |
| Inductance                                    | nH     | <3          |     |     |     |     |     |    |     |     |
| Ambient temperature                           | °C     | -55 to +170 |     |     |     |     |     |    |     |     |

Note 1: Mounted on FR4 board. See Thermal Data and Mounting section for details.

Note 2: Mounted on thermal substrate. See Thermal Data and Mounting section for details.

# **Physical Data**

| Dimens | Dimensions in mm and weight in g |      |      |      |     |      |      |      |      |      |            |
|--------|----------------------------------|------|------|------|-----|------|------|------|------|------|------------|
|        |                                  | L    | L1   | н    | Α   | D    | В    | T1   | Т    | Wt.  |            |
| Value  | Alloy                            | ±0.3 | +0.2 | +0.3 | max | +0.1 | ±0.1 | nom  | nom  | nom  |            |
|        |                                  |      | -0.3 | -0.2 |     | -1   |      |      |      |      |            |
| R0001  | A                                |      | 3.7  |      |     |      |      | 1.42 | 1.42 | 1.46 |            |
| R0002  |                                  |      |      |      |     |      |      | 1.42 | 1.42 | 1.44 | L1 = 0.5 J |
| R0003  | В                                |      | 5    |      |     |      |      | 0.94 | 0.94 | 0.96 |            |
| R0005  | Б                                |      | Э    |      |     |      |      | 0.56 | 0.56 | 0.57 | н          |
| R0006  |                                  | 15   |      | 7.75 | 1   | 4.2  | 0.5  | 0.46 | 0.46 | 0.47 |            |
| R0005  | D                                |      | 4.4  |      |     |      |      | 1.42 | 1.57 | 1.25 |            |
| R001   |                                  |      |      |      |     |      |      | 0.91 | 0.91 | 0.88 |            |
| R002   | С                                |      | 5    |      |     |      |      | 0.7  | 0.44 | 0.61 | ]          |
| R003   |                                  |      |      |      |     |      |      | 0.5  | 0.31 | 0.43 |            |

#### Marking

The component is laser marked with "5930", alloy type, ohmic value and tolerance.

#### **Solvent Resistance**

The component is resistant to all normal industrial cleaning solvents suitable for printed circuits.

#### Construction

The component is formed from a continuous band of E-beam welded (EBW) precision resistive strip. Various alloys are used based on the resistance value.

#### General Note

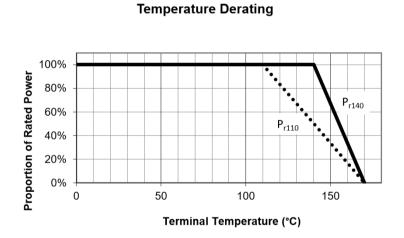
# LRMAP5930

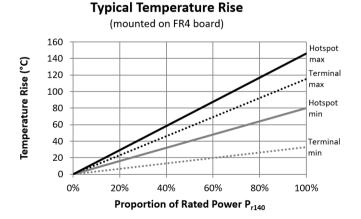


## **Performance Data**

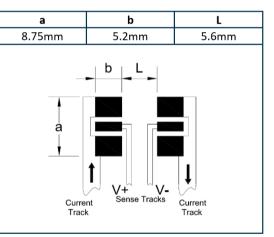
| Test                      | Mashad   | ±ΔR%          |         |  |
|---------------------------|--|---------------|---------|--|
| Test                      | Method   | Typical       | Maximum |  |
| Lood life stability       | 2000 hours, rated power, T <sub>terminal</sub> =110°                   | 0.3           | 0.5     |  |
| Load life stability       | 2000 hours, rated power, T <sub>terminal</sub> =140°                   | 0.7           | 1       |  |
| Short term overload       | 5 seconds, 5 x rated power   | 0.3           | 1       |  |
| High temperature exposure | 1000 hours, T <sub>A</sub> =125°C, unpowered                           | 0.4           | 1       |  |
| Mechanical shock          | 100g, 6ms, half-sine (MIL-STD-202 Method 213)                          | 0.1           | 0.2     |  |
| Biased humidity           | 1000 hours, 85°C, 85%RH, 10% of rated power                            | 0.2           | 0.5     |  |
| Moisture resistance       | MIL-STD-202 method 106   | 0.1           | 0.5     |  |
| Temperature cycle         | 1000 cycles, -55°C to 125°C, 15 minutes dwell                          | 0.1           | 0.5     |  |
| Resistance to solder heat | 260 ± 5°C, 10 ± 1s (MIL-STD-202 Method 210)                            | 0.2           | 0.5     |  |
| Vibration                 | 10-2000Hz, 5g, 20 min, 12 cycles/axis, 3 axes (MIL-STD-202 Method 204) | 0.1           | 0.2     |  |
| Low temperature storage   | 1000 hours, -55°C  | 0.1           | 0.2     |  |
| Resistance to solvents    | MIL-STD-202 Method 215   | No damage     |         |  |
| Solderability             | J-STD-002  | >95% coverage |         |  |

# **Thermal Data & Mounting**

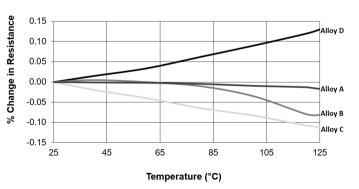




#### Nominal Mounting Pad Dimensions



#### Typical Resistance-Temperature Characteristics

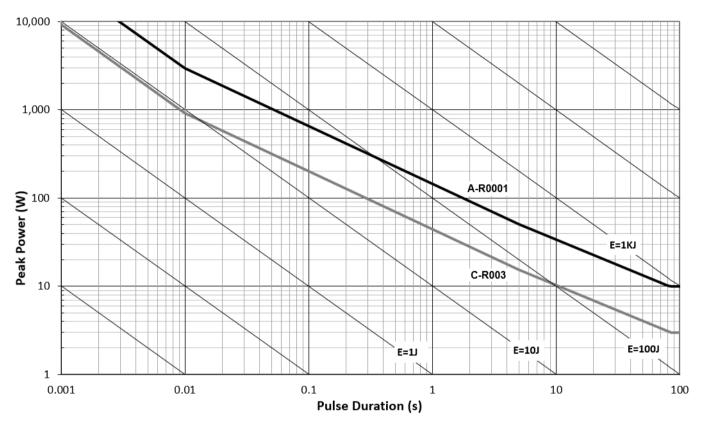


#### General Note



# LRMAP5930

## **Pulse and Overload Performance**



## Single Pulse Power Curve

### Measurement

Resistance testing for the LRMAP5930 is performed on the underside of the copper contacts using the following method.

| Measurement current                  | ≥2mΩ: 1A<br>0.2 to 1mΩ: 3A<br>0.1mΩ: 5A | 4-terminal ohm meter    |  |  |  |  |
|--------------------------------------|---|-------------------------|--|--|--|--|
| Probe spacing along component length | 13.2mm                                  | Resistor contact probes |  |  |  |  |
| Probe spacing across component width | 3.65mm                                  |                         |  |  |  |  |
| Probe tip diameter                   | ≤0.5mm                                  |                         |  |  |  |  |

### Soldering

LRMAP5930 series resistors are suitable for IR reflow soldering. The recommended reflow profile for Pb-free soldering, for example using SAC387 alloy (Sn 95.5%, Ag 3.8%, Cu 0.7%), is as follows:

Pre-heat: 30s to 45s at 180°C Soldering: 20s to 40s at 210°C Peak: 260°C

General Note

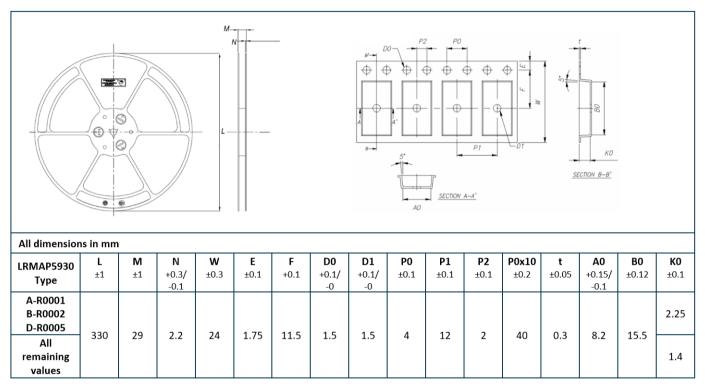
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**LRMAP5930** 



## Packaging

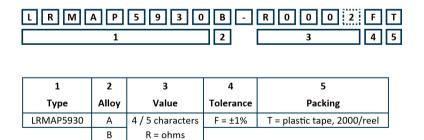
LRMAP5930 resistors are packed in 24mm tape, 2000 pieces per reel.



### **Ordering Procedure**

Example: LRMAP5930B-R0002FT (0.2 milliohms ±1%, Pb-free)

C D



# **Mouser Electronics**

Authorized Distributor

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TT Electronics:

LRMAP5930C-R001FT LRMAP5930D-R0005FT LRMAP5930C-R002FT LRMAP5930B-R0006FT LRMAP5930B-R0005FT R0002FT LRMAP5930B-R0005FT